

**ACADEMIC REGULATIONS  
COURSE STRUCTURE  
AND  
DETAILED SYLLABUS**

**FOR**

**M. Tech (PRODUCTION ENGINEERING)**  
(with effect from 2012-2013)



**JAWAHARLAL NEHRU TECHNOLOGICAL UNIVERSITY HYDERABAD  
KUKATPALLY, HYDERABAD – 500 085.**

## **ACADEMIC REGULATIONS 2009 FOR M.TECH (REGULAR) DEGREE COURSE**

(Effective for the students admitted into first year from the academic year 2009-2010)

The M.Tech Degree of Jawaharlal Nehru Technological University Hyderabad shall be conferred on candidates who are admitted to the program and fulfil all the requirements for the award of the Degree.

### **1.0 ELIGIBILITY FOR ADMISSIONS:**

Admission to the above program shall be made subject to the eligibility, qualifications and specialization prescribed by the University from time to time.

Admissions shall be made on the basis of merit rank obtained by the qualifying candidate at an Entrance Test conducted by the University or on the basis of any other order of merit approved by the University, subject to reservations prescribed by the university from time to time.

### **2.0 AWARD OF M. TECH. DEGREE:**

- 2.1 A student shall be declared eligible for the award of the M.Tech degree, if he pursues a course of study and completes it successfully for not less than two academic years and not more than four academic years.
- 2.2 A student, who fails to fulfill all the academic requirements for the award of the degree within four academic years from the year of his admission, shall forfeit his seat in M.Tech course.
- 2.3 The minimum instruction for each semester 90 clear instruction days.

### **3.0 A. COURSE OF STUDY:**

The following specializations are offered at present for the M.Tech course of study.

1. Advanced Manufacturing Systems
2. Aerospace Engineering
3. Automation
4. Bio-Technology
5. CAD/CAM
6. Chemical Engineering
7. Communication Systems
8. Computer Networks
9. Computer Networks and Information Security
10. Computer Science
11. Computer Science and Engineering
12. Computers and Communication Engineering.
13. Control Engineering
14. Control Systems
15. Design for Manufacturing/ Design and Manufacturing
16. Digital Electronics and Communication Engineering.
17. Digital Electronics and Communication Systems
18. Digital Systems and Computer Electronics
19. Electrical Power Engineering
20. Electrical Power Systems
21. Electronics and Communication Engineering
22. Electronics & Instrumentation
23. Embedded Systems
24. Embedded Systems and VLSI Design
25. Geotechnical Engineering.
26. Heating Ventilation & Air Conditioning.
27. Highway Engineering
28. Image Processing
29. Industrial Engineering and Management
30. Information Technology
31. Machine Design

32. Mechatronics.
33. Neural Networks
34. Parallel Computing
35. Power and Industrial Drives
36. Power Electronics
37. Power Electronics and Electrical Drives
38. Power Engineering and Energy Systems
39. Power System Control and Automation
40. Power System with Emphasis H.V. Engineering / H.V. Engineering
41. Real Time Systems
42. Systems & Signal Processing
43. Software Engineering
44. Structural Engineering
45. Thermal Engineering.
46. VLSI
47. VLSI and Embedded Systems
48. VLSI Design
49. VLSI System Design
50. Web Technology
51. Wireless and Mobile Communication
52. Production Engineering.
53. Power Plant Engineering & Energy Management
54. Nano Technology
55. Geoinformatics and Surveying Technology
56. Engineering Design
57. Microwave & Radar Engineering
58. Environmental Engineering

and any other course as approved by the authorities of the University from time to time.

**3.0 B. Departments officering M.Tech Programmes with specializations mentioned below:**

<b>ECE</b>	Communication Systems Computers and Communication Engineering. Digital Electronics and Communication Engineering. Digital Electronics and Communication Systems Digital Systems and Computer Electronics Electronics and Communication Engineering Electronics & Instrumentation Embedded Systems Embedded Systems and VLSI Design Systems and Signal Processing VLSI VLSI and Embedded Systems VLSI Design VLSI System Design Wireless and Mobile Communication Microwave & Radar Engineering
<b>CSE</b>	Computer Networks Computer Networks and Information Security Computer Science Computer Science and Engineering Image Processing Information Technology Neural Networks Parallel Computing

	Real Time Systems Software Engineering Web Technology
<b>ME</b>	Advanced Manufacturing Systems Automation CAD/CAM Design for Manufacturing/ Design and Manufacturing Heating Ventilation & Air Conditioning. Industrial Engineering and Management Machine Design Mechatronics Thermal Engineering Production Engineering. Power Plant Engineering & Energy Management Engineering Design
<b>EEE</b>	Control Engineering. Control Systems Electrical Power Engineering Electrical Power Systems Power and Industrial Drives Power Electronics Power Electronics and Electrical Drives Power Engineering and Energy Systems Power System Control and Automation Power System with Emphasis H.V. Engineering/ H.V. Engineering
<b>Civil Engg.</b>	Geotechnical Engineering. Highway Engineering Structural Engineering Geo-informatics and Surveying Technology Environmental Engineering
<b>Aeronautical Engg.</b>	Aerospace Engineering
<b>Bio-technology</b>	Bio-Technology
<b>Chemical Engg.</b>	Chemical Engineering
<b>Nano Technology</b>	Nano Technology

#### 4.0 ATTENDANCE:

The programs are offered on a unit basis with each subject being considered a unit.

- 4.1 A candidate shall be deemed to have eligibility to write end semester examinations in a subject if he has put in at least 75% of attendance in that subject.
- 4.2 Shortage of attendance up to 10% in any subject (i.e. 65% and above and below 75%) may be condoned by the College Academic Committee on genuine and valid reasons on representation by the candidate with supporting evidence.
- 4.3 A candidate shall get minimum required attendance at least in three (3) theory subjects in the present semester to get promoted to the next semester. In order to qualify for the award of the M.Tech. Degree, the candidate shall complete all the academic requirements of the subjects, as per the course structure.
- 4.4 Shortage of attendance below 65% shall **in no case be condoned**.
- 4.5 A stipulated fee shall be payable towards condonation of shortage of attendance.

#### 5.0 EVALUATION:

The performance of the candidate in each semester shall be evaluated subject-wise, with a maximum of 100 marks for theory and 100 marks for practicals, on the basis of Internal Evaluation and End Semester Examination.

- 5.1 For the theory subjects 60 marks shall be awarded based on the performance in the End Semester Examination, 40 marks shall be awarded based on the Internal Evaluation.

The internal evaluation shall be made based on the better of the marks secured in the two Mid Term-Examinations conducted one in the middle of the Semester and the other immediately after the completion of instruction. Each mid term examination shall be conducted for a duration of 120 minutes with 4 questions to be answered out of 6 questions.

- 5.2 For practical subjects, 60 marks shall be awarded based on the performance in the End Semester Examinations, 40 marks shall be awarded based on the day-to-day performance as Internal Marks.
- 5.3 There shall be two seminar presentations during I year I semester and II Semesters. For seminar, a student under the supervision of a faculty member, shall collect the literature on a topic and critically review the literature and submit it to the Department in a report form and shall make an oral presentation before the Departmental Committee. The Departmental Committee consists of Head of the Department, supervisor and two other senior faculty members of the department. For each Seminar there will be only internal evaluation of 50 marks. A candidate has to secure a minimum of 50% to be declared successful.
- 5.4 There shall be a Comprehensive Viva-Voce in II year I Semester. The Comprehensive Viva-Voce will be conducted by a Committee consisting of Head of the Department and two Senior Faculty members of the Department. The Comprehensive Viva-Voce is aimed to assess the students' understanding in various subjects he/she studies during the M.Tech course of study. The Comprehensive Viva-Voce is valued for 100 marks by the Committee. There are no internal marks for the Comprehensive viva-Voce
- 5.5 A candidate shall be deemed to have secured the minimum academic requirement in a subject if he secures a minimum of 40% of marks in the End Examination and a minimum aggregate of 50% of the total marks in the End Semester Examination and Internal Evaluation taken together.
- 5.6 In case the candidate does not secure the minimum academic requirement in any subject (as specified in 5.4) he has to reappear for the End Examination in that subject. A candidate shall be given one chance to re-register for each subject provided the internal marks secured by a candidate are less than 50% and he has failed in the end examination. In such case candidate must re-register for the subject(s) and secure required minimum attendance. The attendance of re-registered subject(s) shall be calculated separately to decide upon the eligibility for writing the end examination in those subject(s). In the event of taking another chance, the internal marks and end examination marks obtained in the previous attempt are nullified.
- Conditions to avail the benefit of Improvement of Internal Marks:**
- (i) The candidate should have completed the course work in the College.
  - (ii) The candidate should pass all the subjects for which the internal marks secured are more than 50%, before availing the benefit of Improvement of Internal Marks.
  - (iii) The candidate will be given only one chance for each subject for improvement of internal marks for a maximum of three subjects provided the internal marks secured are less than 50% in each subject and the candidate has failed in the end examination.
  - (iv) In the event of availing improvement of internal marks, the internal marks and the end examination marks, secured in the previous attempt are cancelled.
- 5.7 In case the candidate secures less than the required attendance in any subject(s), he shall not be permitted to appear for the End Examination in that subject(s). He shall re-register the subject when next offered.
- 5.8 Laboratory examination for M.Tech courses must be conducted with two Examiners, one of them being Laboratory Class Teacher and second examiner shall be other Laboratory Teacher.

## **6.0 EVALUATION OF PROJECT / DISSERTATION WORK:**

Every candidate shall be required to submit thesis or dissertation after taking up a topic approved by the Project Review Committee.

- 6.1 A Project Review Committee (PRC) shall be constituted with Principal as chair person Heads of all the Departments which are offering the M.Tech programs and two other senior faculty members.
- 6.2 Registration of Project Work: A candidate is permitted to register for the project work after satisfying the attendance requirement of all the subjects (theory and practical subjects).
- 6.3 After satisfying 6.2, a candidate has to submit, in consultation with his project supervisor, the title, objective and plan of action of his project work to the Departmental Committee for its approval. Only after obtaining the approval of Departmental Committee the student can initiate the Project work.
- 6.4 If a candidate wishes to change his supervisor or topic of the project he can do so with approval of Departmental Committee. However, the Departmental Committee shall examine whether the change of topic/supervisor leads to a major change of his initial plans of project proposal. If so, his date of registration for the project work starts from the date of change of Supervisor or topic as the case may be.
- 6.5 A candidate shall submit status report (in a bound-form) in two stages at least with a gap of 3 months between them.
- 6.6 The work on the project shall be initiated in the beginning of the second year and the duration of the project is for two semesters. A candidate is permitted to submit Project Thesis only after successful completion of theory and practical course with the approval of PRC not earlier than 40 weeks from the date of registration of the project work. For the approval of PRC the candidate shall submit the draft copy of thesis to the Principal (through Head of the Department) and shall make an oral presentation before the PRC.
- 6.7 Three copies of the Project Thesis certified by the supervisor shall be submitted to the College / School / Institute.
- 6.8 The thesis shall be adjudicated by one examiner selected by the University. For this, Principal of the College shall submit a panel of 5 examiners, who are eminent in that field with the help of the concerned guide and head of the department.
- 6.9 If the report of the examiner is not favourable, the candidate shall revise and resubmit the Thesis, in the time frame as described by PRC. If the report of the examiner is unfavourable again, the thesis shall be summarily rejected.
- 6.10 If the report of the examiner is favourable, viva-voce examination shall be conducted by a board consisting of the supervisor, Head of the Department and the examiner who adjudicated the Thesis. The Board shall jointly report candidates work as:
  - A. Excellent
  - B. Good
  - C. Satisfactory
  - D. Unsatisfactory

Head of the Department shall coordinate and make arrangements for the conduct of viva-voce examination.

If the report of the viva-voce is unsatisfactory, the candidate will retake the viva-voce examination after three months. If he fails to get a satisfactory report at the second viva-voce examination, he will not be eligible for the award of the degree.

## 7.0 AWARD OF DEGREE AND CLASS:

After a student has satisfied the requirements prescribed for the completion of the program and is eligible for the award of M. Tech. Degree he shall be placed in one of the following four classes:

Class Awarded	% of marks to be secured
First Class with Distinction	70% and above
First Class	Below 70% but not less than 60%
Second Class	Below 60% but not less than 50%
Pass Class	Below 50% but not less than 40%

(The marks in internal evaluation and end examination shall be shown separately in the marks memorandum)

**8.0 WITH-HOLDING OF RESULTS:**

If the candidate has not paid any dues to the university or if any case of in-discipline is pending against him, the result of the candidate will be withheld and he will not be allowed into the next higher semester. The issue of the degree is liable to be withheld in such cases.

**9.0 TRANSITORY REGULATIONS:**

Candidate who have discontinued or have been detained for want of attendance or who have failed after having undergone the course are eligible for admission to the same or equivalent subjects as and when subjects are offered, subject to 5.5 and 2.0

**10.0 GENERAL:**

- 10.1 The academic regulations should be read as a whole for purpose of any interpretation.
- 10.2 In case of any doubt or ambiguity in the interpretation of the above rules, the decision of the Vice-Chancellor is final.
- 10.3 The University may change or amend the academic regulations and syllabus at any time and the changes and amendments made shall be applicable to all the students with effect from the date notified by the University.
- 10.4 Wherever the word he, him or his occur, it will also include she, her and hers.
- 10.5 There shall be no transfers within the constituent colleges of Jawaharlal Nehru Technological University.

## MALPRACTICES RULES

### DISCIPLINARY ACTION FOR IMPROPER CONDUCT IN EXAMINATIONS

	<b>Nature of Malpractices/Improper conduct</b>	<b>Punishment</b>
	<i>If the candidate:</i>	
1. (a)	Possesses or keeps accessible in examination hall, any paper, note book, programmable calculators, Cell phones, pager, palm computers or any other form of material concerned with or related to the subject of the examination (theory or practical) in which he is appearing but has not made use of (material shall include any marks on the body of the candidate which can be used as an aid in the subject of the examination)	Expulsion from the examination hall and cancellation of the performance in that subject only.
(b)	Gives assistance or guidance or receives it from any other candidate orally or by any other body language methods or communicates through cell phones with any candidate or persons in or outside the exam hall in respect of any matter.	Expulsion from the examination hall and cancellation of the performance in that subject only of all the candidates involved. In case of an outsider, he will be handed over to the police and a case is registered against him.
2.	Has copied in the examination hall from any paper, book, programmable calculators, palm computers or any other form of material relevant to the subject of the examination (theory or practical) in which the candidate is appearing.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted to appear for the remaining examinations of the subjects of that Semester/year. The Hall Ticket of the candidate is to be cancelled and sent to the University.
3.	Impersonates any other candidate in connection with the examination.	The candidate who has impersonated shall be expelled from examination hall. The candidate is also debarred and forfeits the seat. The performance of the original candidate who has been impersonated, shall be cancelled in all the subjects of the examination (including practicals and project work) already appeared and shall not be allowed to appear for examinations of the remaining subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all University examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat. If the imposter is an outsider, he will be handed over to the police and a case is registered against him.
4.	Smuggles in the Answer book or additional sheet or takes out or arranges to send out the question paper during the examination or answer book or additional sheet, during or	Expulsion from the examination hall and cancellation of performance in that subject and all the other subjects the candidate has already appeared including practical



	after the examination.	examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class-work and all University examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat.
5.	Uses objectionable, abusive or offensive language in the answer paper or in letters to the examiners or writes to the examiner requesting him to award pass marks.	Cancellation of the performance in that subject.
6.	Refuses to obey the orders of the Chief Superintendent/Assistant – Superintendent / any officer on duty or misbehaves or creates disturbance of any kind in and around the examination hall or organizes a walk out or instigates others to walk out, or threatens the officer-in-charge or any person on duty in or outside the examination hall of any injury to his person or to any of his relations whether by words, either spoken or written or by signs or by visible representation, assaults the officer-in-charge, or any person on duty in or outside the examination hall or any of his relations, or indulges in any other act of misconduct or mischief which result in damage to or destruction of property in the examination hall or any part of the College campus or engages in any other act which in the opinion of the officer on duty amounts to use of unfair means or misconduct or has the tendency to disrupt the orderly conduct of the examination.	In case of students of the college, they shall be expelled from examination halls and cancellation of their performance in that subject and all other subjects the candidate(s) has (have) already appeared and shall not be permitted to appear for the remaining examinations of the subjects of that semester/year. The candidates also are debarred and forfeit their seats. In case of outsiders, they will be handed over to the police and a police case is registered against them.
7.	Leaves the exam hall taking away answer script or intentionally tears of the script or any part thereof inside or outside the examination hall.	Expulsion from the examination hall and cancellation of performance in that subject and all the other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all University examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat.
8.	Possess any lethal weapon or firearm in the examination hall.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred and forfeits the seat.

9.	If student of the college, who is not a candidate for the particular examination or any person not connected with the college indulges in any malpractice or improper conduct mentioned in clause 6 to 8.	Student of the colleges expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred and forfeits the seat. Person(s) who do not belong to the College will be handed over to police and, a police case will be registered against them.
10.	Comes in a drunken condition to the examination hall.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year.
11.	Copying detected on the basis of internal evidence, such as, during valuation or during special scrutiny.	Cancellation of the performance in that subject and all other subjects the candidate has appeared including practical examinations and project work of that semester/year examinations.
12.	If any malpractice is detected which is not covered in the above clauses 1 to 11 shall be reported to the University for further action to award suitable punishment.	

#### Malpractices identified by squad or special invigilators

1. Punishments to the candidates as per the above guidelines.
2. Punishment for institutions : (if the squad reports that the college is also involved in encouraging malpractices)
  - (i) A show cause notice shall be issued to the college.
  - (ii) Impose a suitable fine on the college.
  - (iii) Shifting the examination center from the college to another college for a specific period of not less than one year.

**JAWAHARLAL NEHRU TECHNOLOGICAL UNIVERSITY HYDERABAD**  
**M. TECH (PRODUCTION ENGINEERING)**  
**COURSE STRUCTURE AND SYLLABUS**

**I YEAR I SEMESTER**

Code	Group	Subject	L	P	Credit
		Theory of Metal Cutting & Tool Design	3	0	3
		Theory of Elasticity and Plasticity	3	0	3
		Advanced Casting and Welding Technologies	3	0	3
		Advanced CAD	3	0	3
	Elective –I	Machine Tool Design & CNC Machines Advanced Manufacturing Processes Materials Technology	3	0	3
	Elective –II	Experimental Techniques & Data Analysis Quality Engineering in Manufacturing Production & Operations Management	3	0	3
	Lab	Production Engineering Lab	0	3	2
		Seminar	-	-	2
		Total Credits (6 Theory + 1 Lab.)			22

**I YEAR II SEMESTER**

Code	Group	Subject	L	P	Credit
		Advanced Metal Forming	3	0	3
		Rapid Prototyping Technologies	3	0	3
		Optimization Techniques and Applications	3	0	3
		Automation in Manufacturing	3	0	3
	Elective -III	Intelligent Manufacturing Systems Finite Element Techniques Design and Manufacture of MEMS & Micro systems	3	0	3
	Elective -IV	Mechatronics Industrial Robotics Design for Manufacture & Assembly	3	0	3
	Lab	Computer Aided Engineering Lab	0	3	2
		Seminar	-	-	2
		Total Credits (6 Theory + 1 Lab.)			22

**II YEAR - I Semester**

Code	Group	Subject	L	P	Credit
		Comprehensive Viva	-	-	2
		Project Seminar	0	3	2
		Project work	-	-	18
		Total Credits			22

**II YEAR - II Semester**

Code	Group	Subject	L	P	Credit
		Project work and Seminar	-	-	22
		Total Credits			22

**THEORY OF METAL CUTTING AND TOOL DESIGN**

**Unit -1**

**Mechanics of Metal Cutting:** Geometry of Metal Cutting Process, Chip formation, Chip thickness ratio, radius of chip curvature, cutting speed, feed and depth of cut – Types of chips chip breakers.

Orthogonal and Oblique cutting processes – definition, Forces and energy calculations (Merchant's Analysis) – Power consumed – MRR- Effect of Cutting variables on Forces, Force measurement using Dynamometers.

**Unit II**

**Single Point Cutting Tool:** Various systems of specifications, single point cutting tool geometry and their inter-relation. Theories of formation of built-up edge and their effect, design of single point contact tools throwaway inserts.

**Unit III**

**Multipoint Cutting Tool:** Drill geometry, design of drills, Rake & Relief angles of twist drill, speed, feed and depth of cut, machining time, forces, milling cutters, cutting speed & feed machining time- design – from cutters.

**Grinding:** Specifications of grinding of grinding wheel, mechanics of grinding, Effect of Grinding conditions on wheel wear and grinding ratio. Depth of cut, speed, machining time, temperature power.

**Unit IV**

**Tool Life and Tool Wear:** Theories of tool wear – adhesion, abrasive and diffusion wear mechanisms, forms of wear, Tool life criteria and machinability index.

Types of sliding contact, real area of contact, laws of friction and nature of frictional force in metal cutting. Effect Tool angle, Economics, cost analysis, mean co-effect of friction.

**Cutting Temperature:** Sources of heat in metal cutting, influence of metal conditions, Temperature distribution, zones, experimental techniques, analytical approach. Use of tool-work thermocouple for determination of temperature. Temperature distribution in Metal Cutting.

**Unit V**

**Tool Design:** Determination of shank size for single point carbide tools, Determining the insert thickness for carbide tools.

Design of jigs and fixtures: Basic principles of location and clamping; Locating methods and devices. Jigs – Definition, Types. General consideration in the design of Drill jigs, Drill bushing, Methods of construction. Fixtures – Vice fixtures, Milling, Boring, Lathe Grinding fixtures.

**TEXT BOOKS;**

1. Metal Cutting Principles/ MC Shaw / Oxford and IBH Publications, New Delhi, 1969
2. Fundamentals of Machining /Boothryd/ Edward Arnold publishers Ltd 1975
3. ' Tool Design ' by David Son / Lacain/ Goud, Tata Me Graw Hill
4. Fundamentals of Tool Design by Wilson fw , ASTME PHI 2010.

**THEORY OF ELASTICITY AND PLASTICITY**

**UNIT-I**

Basic Concepts of Stress : Definition, State of Stress at a point, Stress tensor, invariants of stress tensor, principle stresses, stress ellipsoid, derivation for maximum shear stress and planes of maximum shear stress, octahedral shear stress, Deviatoric and Hydrostatic components of stress, Invariance of Deviatoric stress tensor, plane stress.

**UNIT-I**

Basic concepts of Strain : Deformation tensor, Strain tensor and rotation tensor; invariants of strain tensor, principle strains, derivation for maximum shear strain and planes of maximum shear strain, octahedral shear strain, Deviatoric and Hydrostatic components of strain tensor, Invariance of Deviatoric strain tensor, plane strain.

**UNIT-I**

Generalized Hooke's Law: Stress-strain relationships for an isotropic body for three dimensional stress space, for plane stress and plane strain conditions, differential equations of equilibrium, compatibility equations, Material (D) matrix for Orthotropic Materials.

**UNIT-IV**

True stress and true strain, von-Mise's and Tresca yield criteria, Haigh–Westergard stress space representation of von - Mise's and Tresca yield criteria, effective stress and effective strain, St.Venants theory of plastic flow, Prandtl–Reuss and Levy–Mise's constitutive equations of plastic flow, Strain hardening and work hardening theories, work of plastic deformation.

**UNIT-V**

Analysis methods: Slab method, Slip line field method, uniform deformation energy method, upper and lower bound solutions. Application of Slab method to forging, wire drawing, extrusion and rolling processes.

**Suggested Readings:**

- 1 Timoshenko and Goodier, Theory of Elasticity, Mcgraw Hill Publications 3rd Edition,
- 2 Mad leson, Theory of Plasticity,
- 3 Chakrabarty, Theory of Plasticity, 2nd edition, McGraw Hill Publications 1998
- 4 George E Dieter, Mechanical Metallurgy, McGraw Hill Publications 1988

**ADVANCED CASTING AND WELDING TECHNOLOGIES**

**Unit I**

**Laser Beam Welding:** Types of lasers, equipment, power calculation, applications, dual laser beam welding, use of fibre optics in LBW.

**Friction Stir Welding:** Details of process and process parameters, specific applications.

**Electron Beam Welding;** The interaction of electron beam with matter, mode of heat generation, mode of energy losses, details of the equipment, product design for EBW, case studies.

**Ultrasonic Welding;** Propagation of ultrasonic waves in matter, mode of joint formation, joint types and design of product for ultrasonic welding, details of equipment and case studies cutting and gauging, flame cutting plasma arc welding, laser assisted cutting.

**Unit II**

**Heat flow in Welding:** Significance, theory of heat flow cooling rate determination, selection of welding parameters based on heat flow analysis, residual stresses and distortion. Joint design, analysis of fracture and fatigue of welded joints. Automated welding systems.

**Unit III**

Investment casting, shell moulding, squeeze casting, vacuum casting, counter-gravity flow-pressure casting, directional and monocrystal solidification, squeeze casting, semisolid metal casting, rheocasting.

**Unit IV**

Solidification Gating and Riser, Nucleation and grain growth, solidification of pure metals, short and long freezing range alloys. Gating and riser design calculations, Fluidity and its measurement.

**Unit V**

**CAE Of Welding And Casting:** Design of weldment, application of finite element method in welding – determination of distortion in weldments, modeling of temperature distribution – case studies. Design for casting, application of finite element method in casting-determination of hot spots, location of turbulence and other defects, modeling of flow in molds, modeling of heat transfer in castings- case studies.

**REFERENCE BOOKS;**

1. Ravi B, “Metal Casting: Computer Aided Design and Analysis” Prentice Hall ,2005.
2. Richard L Little, “Welding and Welding Technology” Tata McGraw Hill, 2004.
3. John Campbell, “Casting Practice” Elsevier Science Publishing CO.,2004
4. Larry Jeffus, “ Welding Principles and Applications” Delmar Publishers, 2004.
5. John Campbell “ Casting Butterworth Heinemann, 2003.
6. Klas Weman, :Welding Processes Handbook”, 2003.
7. Howard B Cary, “ Modern Welding Technology” Prentice Hall, 2002
8. Larry Jeffus, “ Welding for Collision Repair “, Delmar Publishers, 1999
9. ASM Hand Book “ Casting”, ASM International 1998.

**ADVANCED CAD**

**UNIT I:**

**CAD TOOLS:** Definition of CAD Tools, Types of system, CAD/CAM system evaluation criteria, brief treatment of input and output devices. Graphics standard, functional areas of CAD, Modeling and viewing, software documentation, efficient use of CAD software.

**GEOMETRICMODELLING:** Types of mathematical representation of curves, wire frame models wire frame entities parametric representation of synthetic curves her mite cubic splines Bezier curves B-splines rational curves

**UNIT II:**

**SURFACE MODELING :**Mathematical representation surfaces, Surface model, Surface entities surface representation, Parametric representation of surfaces, plane surface, rule surface, surface of revolution, Tabulated Cylinder.

**UNIT III:**

**PARAMETRIC REPRESENTATION OF SYNTHETIC SURFACES** - Hermite Bicubic surface, **Bezier** surface, **B-** Spline surface, COONs surface, Blending surface Sculptured surface, Surface manipulation — Displaying, Segmentation, Trimming, Intersection, Transformations (both 2D and 3D).

**UNIT IV:**

**GEOMETRICMODELLING-3D :** Solid modeling, Solid Representation, Boundary Representation (13-rep), Constructive Solid Geometry (CSG). CAD/CAM Exchange : Evaluation of data — exchange format, IGES data representations and structure, STEP Architecture, implementation, ACIS & DXF. Design Applications: Mechanical tolerances, Mass property calculations, Finite Element Modeling and Analysis and Mechanical Assembly.

**Collaborative Engineering:** Collaborative Design, Principles, Approaches, Tools, Design Systems.

**UNIT V:**

Students will be given Engineering Component and student has to design the components and produce its drawing and present it as assignment.

**TEXT BOOKS:**

1. CAD/CAM Theory and Practice / Ibrahim Zeid / Mc Graw Hill international.

**REFERENCE BOOKS:**

1. Mastering CAD/CAM / Ibrahim Zeid / Mc Graw Hill international.
2. CAD/CAM / P.N.Rao / TMH.

**MACHINE TOOL DESIGN AND CNC MACHINES**  
**(Elective-I)**

**Unit –I**

Kinematics of Machine Tools:- shaping of geometrical and real surfaces, Developing and designing of kinematic schemes of machine tools, kinematics structures of lathe, drilling, milling, grinding, gear shaping and gear hobbing machines. Kinematic design of speed and feed boxes. Productivity loss. Stepped and stepless regulation, clutched drive.

**UNIT – II**

Strengths and Rigidity of Machine tool Structures: Basic principles of design for strength. Different types of structures. Overall compliance of machine tools. Design of beds, bases, columns, tables, cross rail for various machines. Various types of guide ways, their relative advantages. Materials for machine tool components including plastic guide way (PTFE)

**UNIT – III**

Analysis of Spindles, Bearings, and Power Screws: Design of spindles subjected to combined bending and torsion. Layout of bearings. Pre-loading. Anti-friction slide ways. Rolling contact hydrodynamic, hydrostatic, Hydrodynamic design of Journal bearings, Magneto bearings.

Machine Tool Vibrations: Effect of vibrations on machine tool. Free and Forced vibrations. Machine tool chatter.

**UNIT – IV**

Computer- Aided Programming: General information, APT programming, Examples apt programming problems (2D machining only). NC programming on CAD/CAM systems, the design and implementation of post processors introduction to CAD/CAM software, automatic Tool Path generation.

**UNIT V**

Tooling for CNC Machines: Interchangeable tooling system, present and qualified tools, coolant fed tooling system, modular fixturing, quick change tooling system, automatic head changers. DNC Systems and Adaptive Control; Introduction, type of DNC systems, advantages and disadvantages of DNC, adaptive control with optimization, Adaptive control with constraints, Adaptive control of machining processes like turning, grinding.

- 1.N.K. Mehta, Machine Tool Design and Numerical Control, Tata McGraw Hill, 1997.
2. Sen and Battacharya, Principles of Machine Tools, Central book publishers, Calcutta 1995.
- 3.SK BASU “Machine Tool Design”
4. McGraw “CAD/CAM”
5. Yorenkoren “Computer Control “ Manufacturing Systems”



**ADVANCED MANUFACTURING PROCESSES**  
**(Elective – I)**

**Unit I**

**Surface treatment:** Scope, Cleaners, Methods of cleaning, Surface coating types, and ceramic and organic methods of coating, economics of coating, Electro forming, Chemical vapour deposition, thermal spraying, Ion implantation, diffusion coating, Diamond coating and cladding.

**Unit II**

**Non-Traditional Machining:** Introduction, need AJM, Parametric Analysis, Process capabilities, USM- Mechanics of Cutting, models, Parametric Analysis, WJM – principles, equipment, generators, analysis of R-C circuits, MRR, Surface finish, WEDM.

**Unit III**

**Laser Beam Machining** – Principles of working, equipment, Material removal rate, Process parameters, performance characterization, applications.

**Plasma Arc Machining** – Principles of working, equipment, Material removal rate, Process Parameters, performance characterization, applications

**Electron Beam Machining** – Principle of working equipment, Material removal rate, Process performance characterization, applications

**Electro Chemical Machining** – Principle of working, equipment, Material removal rate, Process parameters, performance characterization, applications

**Unit IV**

**Processing of ceramics :** Applications characteristics, classification Processing of particulate ceramics, Powder preparations, consolidation, Drying, sintering, Hot compaction, Elastomers, Reinforced plastics, MMC, CMC, Polymer matrix composites.

**Unit V**

**Fabrication of Microelectronics devices:** Crystal growth and wafer preparation, Film deposition oxidation, lithography, bonding and packaging, reliability and yield, Printed Circuit boards, computer aided design in micro electronics, surface mount technology, Integrated circuits economics.

E-Manufacturing, nanotechnology, and micromachining, High speed Machining

**TEXT BOOKS:**

1. Manufacturing Engineering and Technology, Kalpakijian, Adisson Wesley 1995
2. Process and Materials of Manufacturing RA Lindburg 4<sup>th</sup> edition PHI 1990
3. Foundation of MEMS/Chang Liu/ Pearson, 2012
4. Advanced Machining Processes VKJin, Allied Publications.
5. Introduction to Manufacturing Processes, John A Schey, Mc Graw Hill.

**MATERIALS TECHNOLOGY**  
**(Elective –I)**

**UNIT I:**

Elasticity in metals and polymers, mechanism of plastic deformation, role of dislocations, yield stress, shear strength of perfect and real crystals, strengthening mechanism, work hardening, solid solution, grain boundary strengthening. Poly phase mixture, precipitation, particle, fiber and dispersion strengthening, effect of temperature, strain and strain rate on plastic behavior, super plasticity, deformation of non crystalline material

**UNIT II:**

Griffth's Theory, stress intensity factor and fracture Toughness, Toughening Mechanisms, Ductile and Brittle transition in steel, High Temperature Fracture, Creep, Larson – Miller parameter, Deformation and Fracture mechanism maps.

**UNIT III:**

Fatigue, Low and High cycle fatigue test, Crack Initiation and Propagation mechanism and paris Law, Effect of surface and metallurgical parameters on Fatigue, Fracture of non-metallic materials, fatigue analysis, Sources of failure, procedure of failure analysis.

**UNIT IV:**

Motivation for selection, cost basis and service requirements, Selection for Mechanical Properties, Strength, Toughness, Fatigue and Creep. Selection for Surface durability, Corrosion and Wear resistance, Relationship between Materials Selection and Processing, Case studies in Materials Selection with relevance to Aero, Auto , Marine, Machinery and Nuclear Applications.

**UNIT V:**

**MODERN METALLIC MATERIALS:** Dual Steels, Micro alloyed, High Strength Low alloy (HSLA) Steel, Transformation induced plasticity (TRIP) Steel, Maraging Steel, Intermetallics, Ni and Ti Aluminides, Smart Materials, Shape Memory alloys, Metallic Glass Quasi Crystal and Nano Crystalline Materials.

**NONMETALLIC MATERIALS:** Polymeric materials and their molecular structures, Production Techniques for Fibers, Foams, Adhesives and Coatings, structure, Properties and Applications of Engineering Polymers, Advanced Structural Ceramics WC, TiC, TaC, Al<sub>2</sub>O<sub>3</sub>, SiC, Si<sub>3</sub>N<sub>4</sub>, CBN and Diamond – properties, Processing and applications.

**Text Books:**

- 1 Mechanical Behavior of Materials/Thomas H. Courtney/ 2 nd Edition, McGraw Hill, 2000
- 2 Mechanical Metallurgy/George E. Dieter/McGraw Hill, 1998.

**References:**

Selection and use of Engineering Materials 3e/Charles J.A/Butterworth Heiremann.

**JAWAHARLAL NEHRU TECHNOLOGICAL UNIVERSITY HYDERABAD**  
**I YEAR -I SEM. M.Tech (Production Engg.)**

**EXPERIMENTAL TECHNIQUES AND DATA ANALYSIS**  
**(Elective – II)**

**UNIT-I**

Measurement of Cutting Forces: Strain gauge and piezoelectric transducers and their characteristics. Dynamometer construction, Bridge circuits. Instrumentation and calibration. Displacement and strain measurements by photo elasticity. Holography, interferometer, Moir techniques, strain gauge rosettes.

**UNIT-II**

Temperature Measurement: Circuits and instrumentation for different transducers viz, bimetallic, expanding fluid, electrical resistance, thermistor, thermocouples, pyrometers. Flow Measurement : Transducers for flow measurements of Non-compressible and compressible fluids. Obstruction and drag methods. Vortex shredding flow meters. Ultrasonic, Laser Dopler and Hotwire anemometer. Flow visualization techniques, Shadow graphs, Schlieren photography. Interferometer.

**UNIT-III**

Metallurgical Studies: Optical and electron microscopy, X-Ray diffraction, Bragg's Law and its application for studying crystal structure and residual stresses. Electron spectroscopy, electron microprobe. Surface Measurements: Micro hardness, roughness, accuracy of dimensions and forms. 3-D co-ordinate measuring machines.

**UNIT-IV**

Experiment design & data analysis: Statistical methods, Randomized block design, Latin and orthogonal squares, factorial design. Replication and randomization. Data Analysis: Deterministic and random data, uncertainty analysis, tests for significance: Chi-square, student's 't' test. Regression modeling, direct and interaction effects. ANOVA, F-test. Time Series analysis, Autocorrelation and autoregressive modeling.

**UNIT-V**

Taguchi Methods: Experiment design and planning with Orthogonal arrays linear graphs and triangular tables Additive cause effect model. Optimization of response level. Identification of Design and noise factors. Performance evaluation and Optimization by signal to noise ratios. Concept of loss function and its application.

**Suggested Reading:**

- 1 Holman, J.P.: Experimental Methods for Engineers, McGraw Hill Int., New York.
- 2 Venkatesh, V.C., and Chandrasekharan, Experimental Methods in Metal Cutting, Prentice Hall of India, Delhi.
3. Davis, O.V.; The Design and Analysis of Industrial Experiments, Longman, London.
4. Box and Jenkins; Time Series analysis, Forecasting and control, Holden Day, Sanfrancisco.
5. Dove and Adams, Experimental stress analysis and motion measurement, Prentice Hall of India, Delhi.
6. Tapan P. Bagchi, Taguchi Methods Explained, Prentice Hall of India, Delhi.

**QUALITY ENGINEERING IN MANUFACTURING**  
**(Elective II)**

**UNIT I:**

Quality Value and Engineering: An overall quality system, quality engineering in production design, quality engineering in design of production processes. Loss Function and Quality Level: Derivation and use of quadratile loss function, economic consequences of tightening tolerances as a means to improve quality, evaluations and types tolerances.(N-type,S-type and L-type)

**UNIT II:**

Tolerance Design and Tolerancing: Functional limits, tolerance design for N-type. L-type and S-type characteristics, tolerance allocation fbr multiple components. Parameter and Tolerance Design: Introduction to parameter design, signal to noise ratios, Parameter design strategy, some of the case studies on parameter and tolerance designs.

**UNIT III:**

Analysis of Variance (ANOVA): NO-way ANOVA, One-way ANOVA, Two-way ANOVA, Critique of F-test, ANOVA for four level factors, multiple level factors.

**UNIT IV:**

Orthogonal Arrays: Typical test strategies, better test strategies, efficient test strategies, steps in designing, conducting and analyzing an experiment. Interpolation of Experimental Results: Interpretation methods, percent contributor, estimating the mean.

**UNIT V:**

IS[)-9000 Quality System, BDRE, 6.-sigma, Bench making, Quality circles Brain Storming — Fishbone diagram — problem analysis.

**Text Book:**

1. Taguchi Techniques for Quality Engineering / Phillip J. Ross / McGraw Hill, Intl. II Edition, 1995.

**Reference Books:**

1. Quality Engineering in Production systems / G. Taguchi, A. Elsayed et al / Mc.Graw Hill Intl. Edition, **1989**.
2. Taguchi Methods explained: Practical steps to Robust Design / Papan P. Bagchi / Prentice Hall md. Pvt. Ltd., New Delhi.
3. Design of Experiments using the Taguchi Approach/Ranjit K. Roy, John wiley & sons. Inc. 2001.

**PRODUCTION AND OPERATIONS MANAGEMENT**  
**(Elective II)**

**UNIT -1**

Operation Management – Definition – Objectives – Types of production systems – historical development of operations management – Current issues in operation management.

Product design – Requirements of good product design – product development – approaches – concepts in product development – standardization – simplification – Speed to market – Introduction to concurrent engineering.

**UNIT II**

Value engineering – objective – types of values – function & cost – product life cycle- steps in value engineering – methodology in value engineers – FAST Diagram – Matrix Method.

Location – Facility location and layout – Factors considerations in Plant location- Comparative Study of rural and urban sites – Methods of selection plant layout – objective of good layout – Principles – Types of layout – line balancing.

**UNIT III**

Aggregate Planning – definition – Different Strategies – Various models of Aggregate Planning – Transportation and graphical models.

Advance inventory control systems push systems – Material Requirement – Terminology – types of demands – inputs to MRP- techniques of MRP – Lot sizing methods – benefits and drawbacks of MRP –Manufacturing Resources Planning (MRP –II), Pull systems – Vs Push system – Just in time (JIT) philosophy Kanban System – Calculation of number of Kanbans Requirements for implementation JIT – JIT Production process – benefits of JIT.

**UNIT IV**

Scheduling – Policies – Types of scheduling – Forward and Backward Scheduling – Gantt Charts – Flow shop Scheduling – n jobs and 2 machines, n jobs and 3 machines – job shop Scheduling – 2 jobs and n machines – Line of Balance.

**UNIT V**

Project Management – Programming Evaluation Review Techniques (PERT) – three times estimation – critical path – probability of completion of project – critical path method – crashing of simple nature.

**Reference Books:**

- 1 “Operations Management “ by E.S. Buffs
- 2 “Operations Management “Theory and Problems: by Joseph G. Monks.
- 3 “Production Systems Management “ by James I. Riggs.
- 4 “Production and Operations Management “ by Chary.
- 5 “Operations Management “ by Chase
- 6 “Production and Operation Management “ by Panner Selvam
- 7 “Production and Operation Analysis” by Nahima

**PRODUCTION ENGINEERING LAB -I**

List of Experiments:

- 1 Study of the morphology of chips produced from different materials sand machining processes.
- 2 Effect of tool geometry on chip flow direction in simulated orthogonal cutting conditions.
- 3 Study of cutting ratio/chip thickness ratio in simulated orthogonal cutting with different materials and tool geometry.
4. Evaluations of tool face temperature with thermocouple method.
5. Roughness of machined surface. Influence of tool geometry and feed rate.
- 6 Study of the construction and operating parameters of metal spinning Lathe.
- 7 Study of the water hammer equipment and hydrostatic extrusion setup.
8. Extrusion of cylindrical billets through dies of different included angles and exit diameters and their effect on extrusion pressure.
9. Practice and study of blanking and punching process and their characteristic features on mechanical press with existing dies.
- 10 Experiments on TIG and MIG welding to find out the mechanical properties of metals
- 11 ydraulic and Pneumatic circuits
- 12 Study of operation of tool and cutter grinder, twist drill grinder, Centreless grinder
- 13 Determination of cutting forces in turning
- 14 Inspection of parts using tool makers microscope, roughness and form tester
- 15 Studies on PLC programming

**ADVANCED METAL FORMING**

**UNIT - I:**

Fundamentals of Metal Forming: Classification of forming processes, mechanisms of metal forming: slab method, Upper and lower bound analysis, Deformation energy method and finite element method temperature of metal working, hot working, cold working, friction and lubricants.

**UNIT - II:**

Rolling of metals: Rolling processes, forces and geometrical relationship in rolling, simplified analysis, rolling load, rolling variables, theories of cold and hot rolling, problems and defects in rolling, torque and power calculations, Problems.

**UNIT - III:**

Forging: Classification of forging processes, forging of plate, forging of circular discs, open die and closed-die forging, forging defects, and powder metallurgy forging. problems on flow stress ,true strain and forging load.

Press tool design: Design of various press tools and dies like piercing dies, blanking dies, compound dies and progressive blanking dies, design of bending, forming and drawing dies.

**UNIT - IV:**

Extrusion: Classification, Hot Extrusion, Analysis of Extrusion process, defects in extrusion, extrusion of tubes, production of seamless pipes. Problems on extrusion load.

Drawing: Drawing of tubes, rods, and wires: Wire drawing dies, tube drawing process, analysis of wire, deep drawing and tube drawing .Problems on drawforce.

**UNIT - V:**

Sheet Metal forming: Forming methods, Bending, stretch forming, spinning and Advanced techniques of Sheet Metal Forming, Forming limit criteria, defect in formed parts.

Advanced Metal forming processes: HERF, Electromagnetic forming, residual stresses, in-process heat treatment and computer applications in metal forming. problems on Blanking force, Blank diagram in Cup Diagram, Maximum considering shear.

**Text Books:**

1. Mechanical Metallurgy / G.E. Dieter / Tata McGraw Hill, 1998. III Edition
2. Principles of Metal Working / Sunder Kumar

**References:**

1. Principles of Metal Working processes / G.W. Rowe
2. ASM Metal Forming Hand book.

**RAPID PROTOTYPING TECHNOLOGIES**

**Unit – I**

Introduction: Prototyping fundamentals, Historical development, Fundamentals of Rapid Prototyping, Advantages and Limitations of Rapid Prototyping, Commonly used Terms, Classification of RP process, Rapid Prototyping Process Chain: Fundamental Automated Processes, Process Chain.

**Unit – II**

Liquid-based Rapid Prototyping Systems: Stereo lithography Apparatus (SLA): Models and specifications, Process, working principle, photopolymers, photopolymerization, Layering technology, laser and laser scanning, Applications, Advantages and Disadvantages, Case studies. Solid ground curing (SGC): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies

Solid-based Rapid Prototyping Systems: Laminated Object Manufacturing (LOM): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies. Fused Deposition Modeling (FDM): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies.

**Unit-III**

Powder Based Rapid Prototyping Systems: Selective laser sintering (SLS): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies. Three dimensional Printing (3DP): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies.

Rapid Tooling: Introduction to Rapid Tooling (RT), Conventional Tooling Vs. RT, Need for RT. Rapid Tooling Classification: Indirect Rapid Tooling Methods: Spray Metal Deposition, RTV Epoxy Tools, Ceramic tools, Investment Casting, Spin Casting, Die casting, Sand Casting, 3D Keltool process. Direct Rapid Tooling: Direct AIM, LOM Tools, DTM Rapid Tool Process, EOS Direct Tool Process and Direct Metal Tooling using 3DP.

**Unit – IV**

Rapid Prototyping Data Formats: STL Format, STL File Problems, Consequence of Building Valid and Invalid Tessellated Models, STL file Repairs: Generic Solution, Other Translators, Newly Proposed Formats. Rapid Prototyping Software's: Features of various RP software's like Magic's, Mimics, Solid View, View Expert, 3 D View, Velocity 2, Rhino, STL View 3 Data Expert and 3 D doctor.

**Unit –V**

RP Applications: Application – Material Relationship, Application in Design, Application in Engineering, Analysis and Planning, Aerospace Industry, Automotive Industry, Jewelry Industry, Coin Industry, GIS application, Arts and Architecture. RP Medical and Bioengineering Applications: Planning and simulation of complex surgery, Customized Implants & Prosthesis, Design and Production of Medical Devices, Forensic Science and Anthropology, Visualization of Biomolecules.

**Suggested Reading:**

- 1 Rapid prototyping: Principles and Applications - Chua C.K., Leong K.F. and LIM C.S, World Scientific publications, Third Edition, 2010.
- 2 Rapid Manufacturing – D.T. Pham and S.S. Dimov, Springer, 2001
- 3 Whalers Report 2000 – Terry Wohlers, Wohlers Associates, 2000  
Rapid Prototyping & Manufacturing – Paul F.Jacobs, ASME Press, 1996.



**OPTIMIZATION TECHNIQUES AND APPLICATIONS**

**UNIT- I:**

**Single Variable Non-Linear Unconstrained Optimization:** One dimensional Optimization methods:- Uni-modal function, elimination methods, Fibonacci method, golden section method, interpolation methods – quadratic & cubic interpolation methods.

**UNIT- II:**

**Multi variable non-linear unconstrained optimization:** Direct search method – Univariant method - pattern search methods – Powell's- Hook -Jeeves, Rosenbrock search methods- gradient methods, gradient of function, steepest decent method, Fletcher Reeves method, variable metric method.

**UNIT- III:**

**Linear Programming** – Formulation – Sensitivity analysis. Change in the constraints, cost coefficients, coefficients of the constraints, addition and deletion of variable, constraints. Simulation – Introduction – Types- steps – application – inventory – queuing – thermal system

**UNIT- IV:**

**Integer Programming-** Introduction – formulation – Gomory cutting plane algorithm – Zero or one algorithm, branch and bound method

**Stochastic Programming:** Basic concepts of probability theory, random variables- distributions-mean, variance, correlation, co variance, joint probability distribution- stochastic linear, dynamic programming.

**UNIT- V:**

**Geometric Programming:** Posynomials – arithmetic - geometric inequality – unconstrained G.P- constrained G.P

**Non Traditional Optimization Algorithms:** Genetics Algorithm-Working Principles, Similarities and Differences between Genetic Algorithm & Traditional Methods. Simulated Annealing- Working Principle-Simple Problems.

**Text Books:**

1. Optimization theory & Applications / S.S.Rao / New Age International.
2. Optimization for Engineering Design, Kalyanmoy Deb, PHI

**Reference Books:**

- 1) S.D.Sharma / Operations Research
- 2) Operation Research / H.A.Taha /TMH
- 3) Optimization in operations research / R.L.Rardin
- 4) Optimization Techniques /Benugundu & Chandraputla / Pearson Asia.
- 5) Optimization Techniques theory and practice / M.C.Joshi, K.M.Moudgalya/ Narosa Publications

**AUTOMATION IN MANUFACTURING**

**UNIT-I:**

**Introduction to Automation:** Automation in Production Systems-Automated Manufacturing Systems, Computerized Manufacturing Support Systems, Reasons for Automation, Automation Principles and Strategies. Manufacturing operations, Production Concepts and Mathematical Models. Costs of Manufacturing Operations, , Basic Elements of an Automated Systems, Advanced Automation Functions, Levels of automation.

**UNIT-II:**

Introduction to Material Handling, Overview of Material Handling Equipment, Considerations in Material Handling System Design, The 10 Principles of Material Handling. Material Transport Systems, Automated Guided Vehicle Systems, Monorails and other Rail Guided Vehicles, Conveyor Systems, Analysis of Material Transport Systems. Storage Systems, Storage System Performance, Storage Location Strategies, Conventional Storage Methods and Equipment, Automated Storage Systems, Engineering Analysis of Storage Systems. Automatic data capture-overview of Automatic identification methods, bar code technology, other ADC technologies.

**UNIT -III:**

Manual Assembly Lines - Fundamentals of Manual Assembly Lines, Alternative Assembly Systems, Design for Assembly, Analysis of Single Model Assembly Lines, Line balancing problem, largest candidate rule, Kilbridge and Wester method, and Ranked Positional Weights Method, Mixed Model Assembly Lines, Considerations in assembly line design.

**UNIT-IV:**

Transfer lines, Fundamentals of Automated Production Lines, Storage Buffers, and Applications of Automated Production Lines. Analysis of Transfer Lines with no Internal Storage, Analysis of Transfer lines with Storage Buffers.

**UNIT-V:**

Automated Assembly Systems, Fundamentals of Automated Assembly Systems, Design for Automated Assembly, and Quantitative Analysis of Assembly Systems - Parts Delivery System at Work Stations, Multi-Station Assembly Machines, Single Station Assembly Machines , Partial Automation.

**Text Books:**

1. Automation, Production systems and computer integrated manufacturing, Mikel P. Groover/ Pearson Education.

**Reference Books:**

1. CAD CAM : Principles, Practice and Manufacturing Management / Chris Mc Mohan, Jimmie Browne / Pearson edu. (LPE)
2. Automation, Buckingham W, Haper & Row Publishers, New York, 1961
3. Automation for Productivity, Luke H.D, John Wiley & Sons, New York, 1972.

**INTELLIGENT MANUFACTURING SYSTEMS**  
**(Elective – III)**

**UNIT - I:**

Computer Integrated Manufacturing Systems – Structure and functional areas of CIM system - CAD, CAPP, CAM, CAQC, ASRS. Advantages of CIM.

Manufacturing Communication Systems – MAP/TOP, OSI Model, Data Redundancy, Top-down and Bottom-up Approach, Volume of Information. Intelligent Manufacturing – System Components, System Architecture and Data Flow, System Operation.

**UNIT - II:**

Components of Knowledge Based Systems – Basic Components of Knowledge Based Systems, Knowledge Representation, Comparison of Knowledge Representation Schemes, Inference Engine, Knowledge Acquisition.

**UNIT - III:**

Machine Learning – Concept of Artificial Intelligence, Conceptual Learning, Artificial Neural Networks - Biological Neuron, Artificial Neuron, Types of Neural Networks, Applications in Manufacturing

**UNIT - IV:**

Automated Process Planning – Variant Approach, Generative Approach, Expert Systems for Process Planning, Feature Recognition, Phases of Process planning

Knowledge Based System for Equipment Selection (KBSES) – Manufacturing system design, Equipment Selection Problem, Modeling the Manufacturing Equipment Selection Problem, Problem Solving approach in KBSES, Structure of the KBSES.

**UNIT - V:**

Group Technology: Models and Algorithms – Visual Method, Coding Method, Cluster Analysis Method, Matrix Formation – Similarity Coefficient Method, Sorting-based Algorithms, Bond Energy Algorithm, Cost Based method, Cluster Identification Method, Extended CI Method. Knowledge Based Group Technology - Group Technology in Automated Manufacturing System, Structure of Knowledge based system for group technology (KBSGT) – Data Base, Knowledge Base, Clustering Algorithm.

**Text Books:**

1. Intelligent Manufacturing Systems, Andre Kusaic.
2. Artificial Neural Networks, Yagna Narayana
3. Automation, Production Systems and CIM, Groover M.P.
4. Neural Networks, Wassarman.

**FINITE ELEMENT TECHNIQUES**  
**(Elective III)**

**UNIT-I**

Introduction to Finite Element Method of solving field problems. Stress and Equilibrium. Boundary conditions. Strain-Displacement relations. Stress-strain relations. One Dimensional Problem: Finite element modeling. Local, natural and global coordinates and shape functions. Potential Energy approach : Assembly of Global stiffness matrix and load vector. Finite element equations, treatment of boundary conditions. Quadratic shape functions.

**UNIT-II**

Analysis of trusses and frames: Analysis of plane truss with number of unknowns not exceeding two at each node. Analysis of frames with two translations and a rotational degree of freedom at each node. Analysis of Beams: Element stiffness matrix for two noded, two degrees of freedom per node for beam element.

**UNIT-III**

Finite element modeling of two dimensional stress analysis problems with constant strain triangles and treatment of boundary conditions. Two dimensional four noded isoparametric elements and numerical integration. Finite element modeling of Axisymmetric solids subjected of axisymmetric loading with triangular elements. Convergence requirements and geometric isotropy.

**UNIT-IV**

Steady state heat transfer analysis: One dimensional analysis of a fin and two dimensional conduction analysis of thin plate. Time dependent field problems: Application to one dimensional heat flow in a rod. Dynamic analysis: Formulation of finite element modeling of Eigen value problem for a stepped bar and beam. Evaluation of Eigen values and Eigen vectors. Analysis of a uniform shaft subjected to torsion using Finite Element Analysis.

**UNIT-V**

Finite element formulation of three dimensional problems in stress analysis. Finite Element formulation of an incompressible fluid. Potential flow problems Bending of elastic plates. Introduction to non-linear problems and Finite Element analysis software.

**Suggested Reading:**

- 1 Tirupathi R Chandraputla and Ashok. D. Belegundu, Introduction of Finite Element in Engineering, Prentice Hall of India, 1997.
- 2 Rao S.S., The Finite Element Methods in Engineering, Pergamon Press, 1989.
- 3 Segerland. L.J., Applied Finite Element Analysis, Wiley Publication, 1984.
- 4 Reddy J.N., An Introduction to Finite Element Methods, Mc Graw Hill Company, 1984.

**DESIGN AND MANUFACTURING OF MEMS AND MICRO SYSTEMS**  
**(Elective-III)**

**UNIT - I:**

**Overview and working principles of MEMS and Microsystems:** MEMS & Microsystems, Evolution of Micro fabrication, Microsystems & Microelectronics, Microsystems & miniaturization, Applications of MEMs in Industries, Micro sensors, Micro actuation, MEMS with Micro actuators Micro accelerometers, Micro fluidics

**UNIT - II:**

**Engineering Science for Microsystems Design and Fabrication:** Atomic structure of Matter, Ions and Ionization, Molecular Theory of Matter and Intermolecular Forces, Doping of Semiconductors, The Diffusion Process, Plasma Physics, Electrochemistry, Quantum Physics.

**UNIT - III:**

**Engineering Mechanics for Microsystems Design:** Static Bending of Thin plates, Mechanical Vibration, Thermo mechanics , Fracture Mechanics, Thin- Film Mechanics, Overview of Finite Element Stress Analysis

**UNIT - IV:**

**Thermo Fluid Engineering & Microsystems Design:** Overview of Basics of Fluid Mechanics in Macro and Mesoscales, Basic equations in Continuum Fluid Dynamics, Laminar Fluid Flow in Circular Conduits, Computational Fluid Dynamics, Incompressible Fluid Flow in Micro conduits, Fluid flow in Sub micrometer and Nano scale, Overview of Heat conduction in Solids, Heat Conduction in Multilayered Thin films and in solids in sub micrometer scale, Design Considerations, Process Design Mechanical Design, Mechanical design using FEM, Design of a Silicon Die for a Micro pressure sensor.

**UNIT V:**

**Materials for MEMS & Microsystems and their fabrication:** Substrates and Wafers, Active substrate materials, Silicon as a substrate material, Silicon compounds, Silicon Piezoresistors, Gallium Arsenide, Quartz, Piezoelectric Crystals and Polymers, Photolithography, Ion implantation, Diffusion and oxidation, Chemical and Physical vapor deposition, etching, Bulk micro manufacturing, Surface Micromachining, The LIGA Process.

**Text Book:**

1. Tia-Ran Hsu, MEMS & Microsystems. Design & Manufacturing, TMH 2002
2. Foundation of MEMS/ Chang Liu/Pearson, 2012

**References:**

1. Maluf, M., "An Introduction to Microelectromechanical Systems Engineering". Artech House, Boston 2000
2. Trimmer , W.S.N., "Micro robots and Micromechnaical Systems", Sensors & Actuators, Vol 19, 1989
3. Trim., D.W., "Applied Partial Differential Equations"., PWS-Kent Publishing, Boston, 1990

**MECHATRONICS**  
**(Elective – IV)**

**Unit — I:** Introduction: Definition of Mechatronics products, Design Considerations and Tradeoffs. Overview of Mechatronic products. Intelligent Machine vs Automatic. Machine Economic and Social Justification.

Actuators and Motion Control: Characteristics of Mechanical, electrical, Hydraulic and pneumatic actuators and their limitations. Control parameters and system objectives. Mechanical configurations. Popular control system configurations. S-curve, Motor/Load inertia matching. Design with linear slides.

**Unit-II:** Motion control Algorithms: significance of feed forward control loops, shortfalls, Fundamental concepts of adaptive and fuzzy control. Fuzzy logic compensatory control of transformation and deformation non-linearities.

**Unit-III:** Architecture of intelligent Machines: Introduction to Microprocessor and programmable logic controllers and identification of system, System design Classification. Motion control aspects in Design.

**UNIT-IV:**

Manufacturing Data Bases: Data Base management system, CAD/CAM Data bases, Graphic Data Base, Introduction to object oriented concepts, objects oriented model language interface, procedures and methods in creation, edition and manipulation of Data.

**Unit-V:**

Sensor Interfacing: Analog and Digital Sensors for Motion Measurement, Digital Transducers, Human — Machine and Machine — Machine Interfacing devices and strategy.

Machine Vision: Feature and Pattern Recognition methods, concepts of perception and cognition in decision making.

**References**

1 “Designing Intelligent Machines”. open University, London.

Michel B. Hirst and David G. Alciatore,”

Introduction to Mechatronics and Measurement systems, “Tata MC Graw 11111.

I. C.W. Desha, “ Control sensors and actuators,” Prentice Hall.

**INDUSTRIAL ROBOTICS**  
**(Elective – IV)**

**UNIT: I**

Introduction: Automation and Robotics, Robot anatomy, robot configuration, motions joint notation work volume, robot drive system, control system and dynamic performance, precision of movement.

Control System And Components: basic concept and modais controllers control system analysis, robot activation and feedback components. Positions sensors, velocity sensors, actuators sensors, power transmission system.

**UNIT: II**

MOTION ANALYSIS ANI) **CONTROL:** Manipulator kinematics, position representation forward transformation, homogeneous transformation, manipulator path control, robot dynamics, configuration of robot controller,

**UNIT: III**

**END EFFECTORS:** Grippers-types, operation, mechanism, force analysis, tools as end effectors consideration in gripper selection and design. **SENSORS:** Desirable features, tactile, proximity and range sensors, uses sensors in robotics.

**MACHINE VISION:** Functions, Sensing and Digitizing-imaging, Devices, Lighting techniques, Analog to digital single conversion, image storage, Image processing and Analysis-image data reduction, Segmentation feature extraction. Object recognition, training the vision system, Robotics application.

**UNIT: IV**

**ROBOT PROGRAMMING:** Lead through programming, Robot programming as a path in space, Motion interpolation, WAIT, SINONAL AND DELAY commands, Branching capabilities and Limitations.

**ROBOT LANGUAGES:** Textual robot Janguages, Generation, Robot language structures, Elements in function.

**UNIT: V**

**ROBOT CELL DESGIN AND CONTROL:** Robot cell layouts-Robot centered cell, In-line robot cell, Considerations in work design, Work and control, Inter locks, Error detect ion, Work eel 1 controller.

**ROBOT APPLiCATION:** Material transfer, Machine loading/unloading. Processing operation, Assembly and Inspection, Feature Application.

**Text Books:**

1. Industrial robotics, Mikell P.Groover/McGraw Hill.
2. Robotics, K.S.Fu / McGraw Hill.

**DESIGN FOR MANUFACTURING AND ASSEMBLY**  
**(Elective IV)**

**UNIT I:**

Introduction: Design philosophy steps in Design process — General Design rules for manufacturability — basic principles of design Ling for economical production — creativity in design. Materials: Selection of Materials for design Developments in Material technology - - criteria for material selection — Material selection interrelationship with process selection process selection charts.

**UNIT II:**

**MACHINING PROCESS:** Overview of various machining processes -- general design rules for machining - Dimensional tolerance and surface roughness — Design for machining — Ease — Redesigning of components for machining ease with suitable examples. General design recommendations for machined parts.

**METAL CASTING:** Appraisal of various casting processes, selection of casting process, - general design considerations for casting — casting tolerances — use of solidification simulation in casting design — product design rules for sand casting.

**UNIT III:**

**METAL JOINING:** Appraisal of various welding processes, Factors in design of weidments — general design guidelines — pre and post treatment of welds — effects of thermal stresses in weld joints — design of brazed joints. Forging — Design factors for Forging — Closed die forging design — parting lines of die5 drop forging die design — general design recommendations. Extrusion & Sheet Metal Work: Design guidelines for extruded sections - design principles for Punching, Blanking, Bending, Deep Drawing — Keeler Goodman Forming Line Diagram — Component Design for Blanking.

**UNIT-IV**

**ASSEMBLE ADVANTAGES:** Development of the assemble process, choice of assemble method assemble advantages social effects of automation.

**AUTOMATIC ASSEMBLY TRANSFER SYSTEMS :** Continuous transfer, intermittent transfer, indexing mechanisms, and operator - paced free – transfer machine.

**UNIT-V:**

**DESIGN OF MANUAL ASSEMBLY:** Design for assembly fits in the design process, general design guidelines for manual assembly, development of the systematic DFA methodology, assembly efficiency, classification system for manual handling, classification system for manual insertion and fastening, effect of part symmetry on handling time, effect of part thickness and size on handling time, effect of weight on handling time, parts requiring two hands for manipulation, effects of combinations of factors, effect of symmetry effect of chamfer design on insertion operations, estimation of insertion time.

**Text Book:**

1. Geoffrey Boothroyd, "Assembly Automation and Product Design", Marcel Dekker Inc., NY, 1992.
2. Engineering Design – Material & Processing Approach – George E. Deiter, McGraw Hill Intl. 2<sup>nd</sup> Ed. 2000.

**Reference Books:**

1. Geoffrey Boothroyd, "Hand Book of Product Design" Marcel and Dekken, N.Y. 1990.
2. A Delbainbre "Computer Aided Assembly London, 1992.



**COMPUTER AIDED ENGINEERING LAB II**

Features and selection of CNC turning and milling centers. Practice in part programming and operation of CNC turning machines, subroutine techniques and use of cycles. Practice in part programming and operating a machining center, tool planning and selection of sequences of operations, tool setting on machine, practice in APT based NC programming.

Geometric Modeling of 2D & 3D objects by using any CAD packages.

Analysis of Objects by using any Analysis packages.

**CAD Package References:**

**AUTO CAD**

PROE

CATIA V5

UNIGRAPHICS

IRON CAD

**ANALYSIS Package References:**

ANSYS

The students will be given training on the use and application of the following software to manufacturing problems;

- 1) Auto MOD Software
- 2) PROMOD
- 3) SLAM – II
- 4) CAFIMS
- 5) Flexsim

They also learn how to write sub routines in C-language and interlinking with the above packages.

Problems for modeling and simulation experiments:

- 1) AGV planning
- 2) ASRS simulation and performance evaluation
- 3) Machines, AGVs and AS/RS integrated problems
- 4) JIT system
- 5) Kanban flow
- 6) Material handling systems
- 7) M.R.P. Problems
- 8) Shop floor scheduling etc.